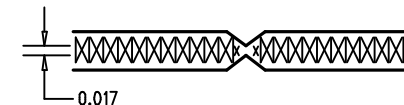


REVISIONS			
REV	DESCRIPTION	APPR	DATE
A	PROTOTYPE RELEASE		

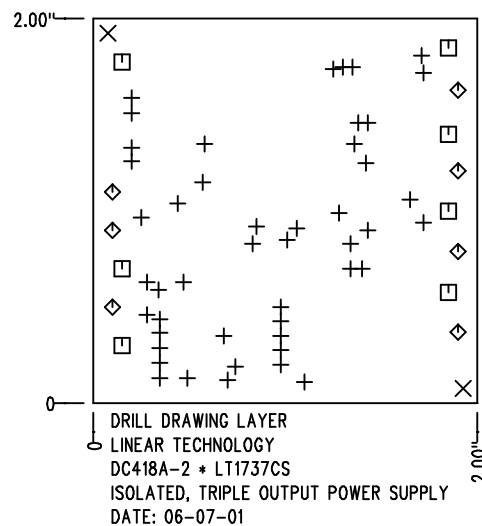
SIZE	QTY	SYM	PLTD
0.02	47	+	PLTD
0.07	2	×	NPLTD
0.094	7	□	PLTD
0.043	7	◇	PLTD

# NOTES : Unless Otherwise Specified


1. MATERIAL : FR4 OR EQUIVALENT EPOXY, 2 OZ. COPPER CLAD  
THICKNESS .062 +/- .006 TOTAL OF 4 LAYERS.
2. FINISH : ALL PLATED HOLES .001 MIN. / .0015 MAX. COPPER PLATE  
ELECTRODEPOSITED TIN-LEAD COMPOSITION  
BEFORE REFLOW , SOLDER MASK OVER BARE COPPER (SMOBC).
3. SOLDER MASK : BOTH SIDES USING LPI OR EQUIVALENT.
4. SILKSCREEN : USING WHITE NON-CONDUCTIVE EPOXY INK.
5. UNUSED SMD COMPONENTS SHOULD BE FREE OF SOLDER.
6. FILL UP ALL VIAS WITH SOLDER.
7. SCORING:



8. PLEASE LOOK AT THE README FILE FOR THE OTHER REQUIREMENTS.



SHOWN FROM COMPONENT SIDE

APPROVALS			 <b>LINEAR TECHNOLOGY</b> 1630 McCarthy Blvd. Milpitas, CA 95035 PH: (408)432-1900		
DRAWN	INIT	DATE			
CHECK			<b>TITLE:</b> Fabrication Drawing <b>ISOLATED, TRIPLE OUTPUT POWER SUPPLY</b>		
DESIGN	KIM T.	06-07-01			
ENGR	JOHN SH.	06-07-01	<b>SIZE</b> A <b>DEMO</b> DC418A-2*LT1737CS <b>REV.</b> A		
SCALE = NONE			<b>DES-</b> 0000 <b>SHT</b> 1 of 1		